

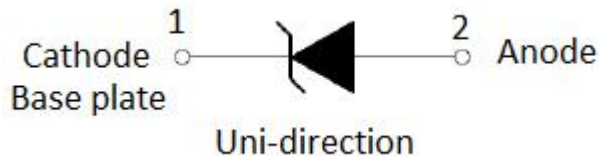
SM5S22 TRANSIENT VOLTAGE SUPPRESSOR



Mechanical Data

- Case: DO-218AB
- Molding compound meets UL 94 V-0 flammability rating Base P/NHE3 - RoHS compliant, high reliability/ automotive grade (AEC Q101 qualified)
- Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102
- Polarity: Heatsink is anode

Circuit Diagram



Features

- Low leakage current
- Low forward voltage drop
- High surge capability
- Base plate is cathode
- This is a Pb – Free Device
- Additional testing can be offered upon request

Maximum Ratings and Thermal Characteristics@T_A=25°C unless otherwise specified

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation at T _A =25°C by 10x1000µs Waveform	P _{PPM}	3600	W
Power dissipation on infinite heatsink at TC = 25°C (fig. 1)	P _D	5.0	W
Maximum working stand-off voltage	V _{WM}	22	V
Peak forward surge current 8.3 ms single half sine-wave	I _{FSM}	500	A
Typical thermal resistance, junction to case	R _{θJC}	1.0	°C/W
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55 to 175	°C

Electrical Characteristics @ $T_A=25^\circ\text{C}$ unless otherwise specified

DEVICE TYPE	REVERSE STAND-OFF VOLTAGE V_{RWM} (V)	BREAKDOWN VOLTAGE V_{BR} (V) MIN. @ I_T	BREAKDOWN VOLTAGE V_{BR} (V) MAX. @ I_T	TEST CURRENT I_T (MA)
SM5S22	22	24	30	10

PARAMETER	TEST CONDITIONS	SYMBOL	TYP.	MAX.	UNIT
Peak pulse current at 10/1000 μ s waveform	-	I_{PP}	-	91	A
Clamping voltage	$I_{PP} = 91\text{ A}$	V_C	-	39.4	V
Instantaneous forward voltage(Note 1)	$I_F = 100\text{ A}$	V_F	-	2.0	V
Reverse leakage current	Rated V_{WM} , $T_J = 25^\circ\text{C}$	I_R	-	2	μA

Note: 1. Measured on 8.3 ms single half sine-wave or equivalent square wave.

Ordering Information

Device	Package	Shipping
SM5S22	DO-218AB (Pb-Free)	750pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram


SM5S22 = Part Name

Ratings and Characteristics Curves

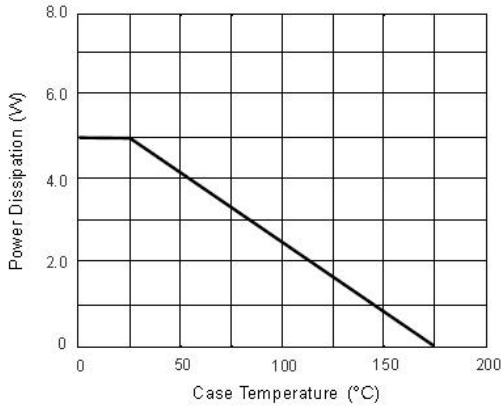


Figure 1. Power Derating Curve

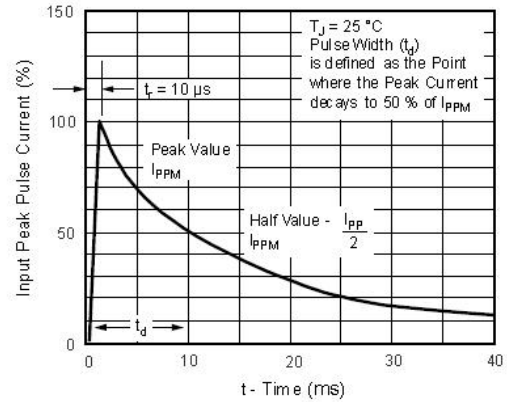


Figure 3. Pulse Waveform

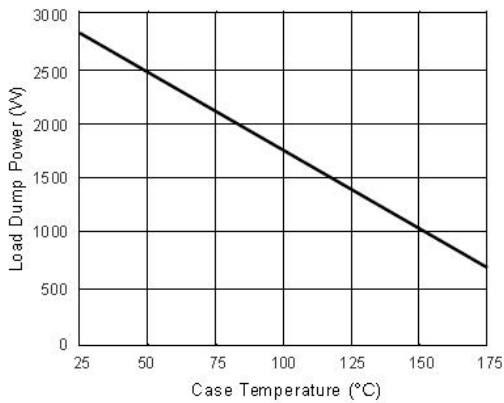


Figure 2. Load Dump Power Characteristics
(10 ms Exponential Waveform)

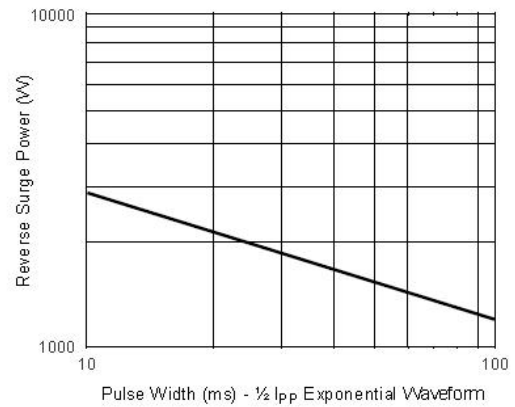


Figure 4. Reverse Power Capability

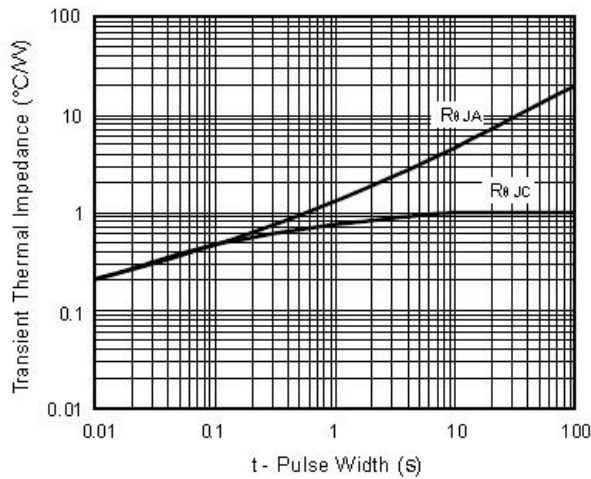
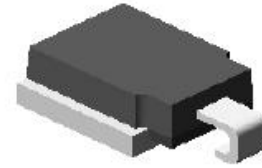
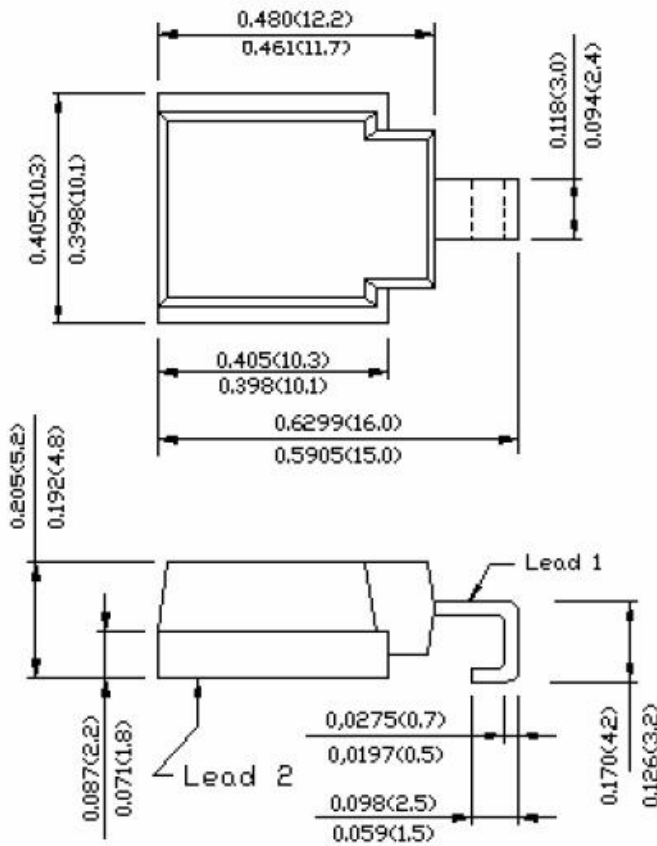
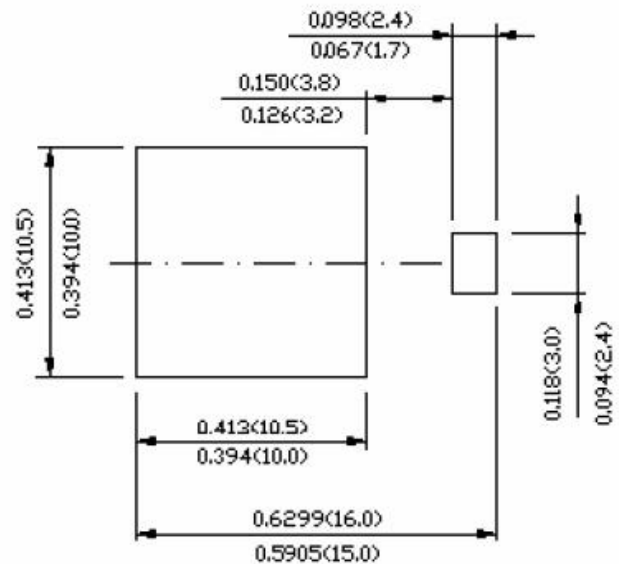


Figure 5. Typical Transient Thermal Impedance

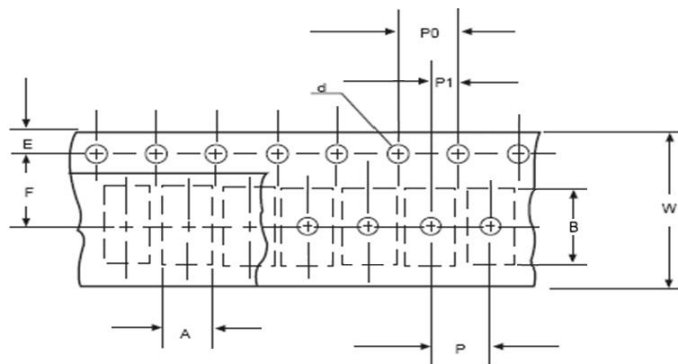
Mechanical Dimensions DO-218AB(Inches/Millimeters)



Mounting pad layout



Carrier Tape Specification DO-218AB



SYMBOL	Millimeters	
	Min.	Max.
A	10.5	11.5
B	16.5	17.5
d	1.4	1.6
E	1.40	1.60
F	5.60	5.70
P	3.90	4.10
P0	3.90	4.10
P1	1.90	2.10
W	23.5	24.5



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